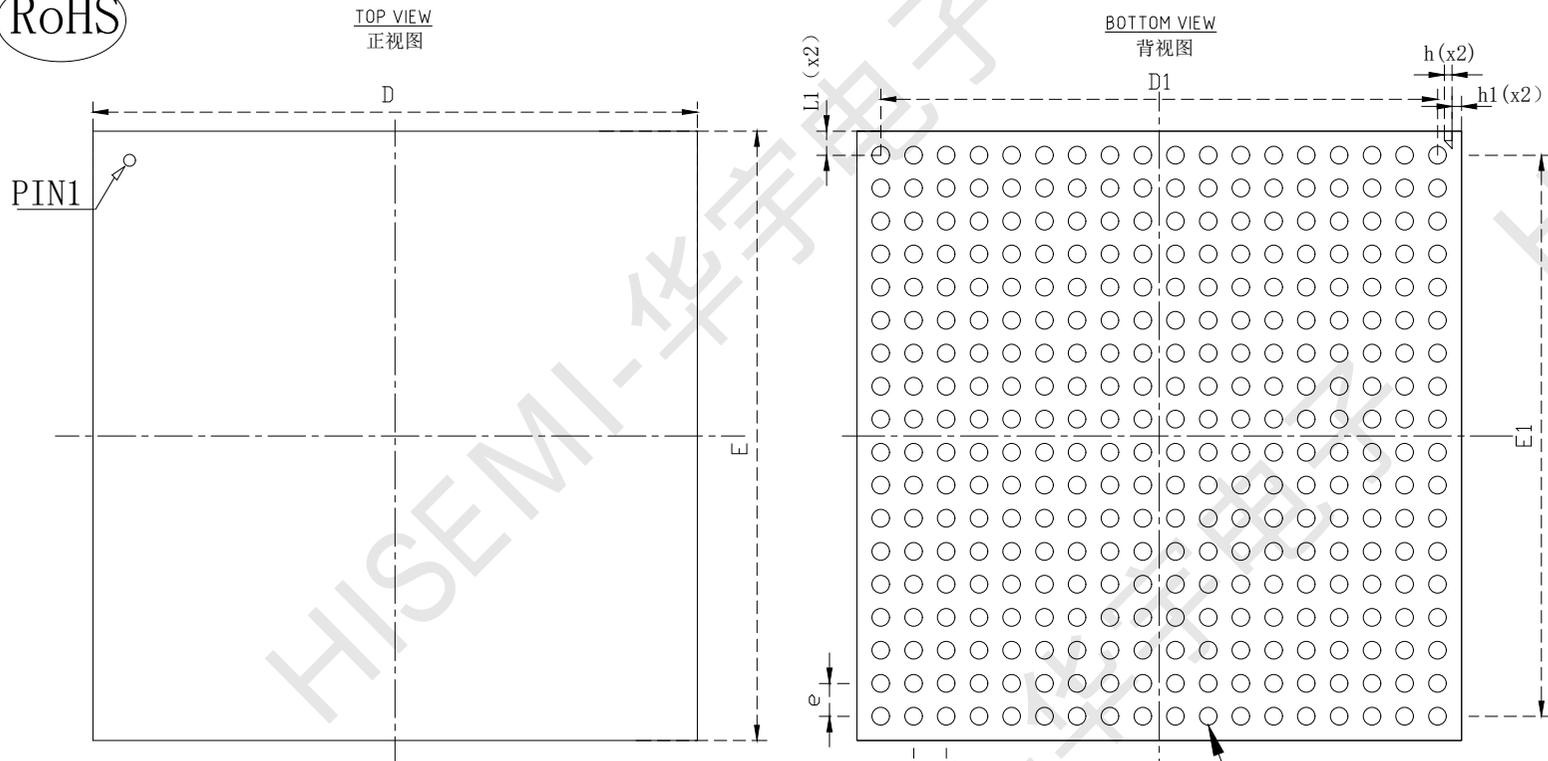
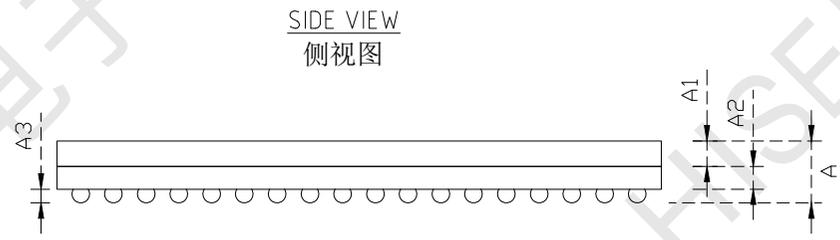


RoHS



机械尺寸/mm			
字符 SYMBOL	最小值 MIN	典型值 NOMINAL	最大值 MAX
A	1.120	1.220	1.320
D	11.000	12.000	13.000
E	11.000	12.000	13.000
A1	0.450	0.500	0.550
A2	0.420	0.450	0.480
A3	0.220	0.270	0.320
e	0.650 BSC		
b	ø0.300	ø0.350	ø0.400
D1	10.05	11.05	12.05
E1	10.050	11.050	12.050
L1	0.425	0.475	0.525
h	0.100	0.150	0.200
h1	0.130	0.180	0.230

øb (回流焊前)



 <b>池州华宇电子科技股份有限公司</b> CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD				制图: Draw	NINGLIN 2025.12.15
				HY-POD-BGA0124	
PACKAGE OUTLINE DIMENSIONS BGA324L (12×12×1.22-P0.65)				审核: Checker	
页数 page	单位 unit	比例 scale	视图 view	核准: Approved	
1	mm	1:1	☉ □		